



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
PATENT APPLICATION

In re Application of:

Abbott et al. Atty. Docket: TI-33737A
Serial No.: 10//762,122 Art Unit: 2812
Filed: 01/20/2004 Examiner: Scott Geyer
For: **SEMICONDUCTOR LEADFRAMES PLATED WITH THICK
NICKEL, MINIMUM PALLADIUM AND PURE TIN**

CERTIFICATE OF MAILING 37 CFR §1.8(a)

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, Alexandria, VA 22313-1450 on the date indicated below.

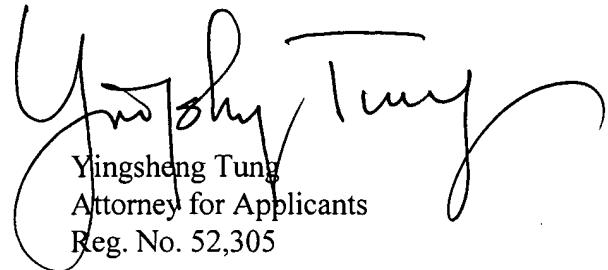
7-5-2005
Jackie McBride
Jackie McBride

LETTER TO THE OFFICIAL DRAFTSPERSON

Sir:

Please replace the drawings now on file with the enclosed set of four (4) sheets of replacement formal drawings in the patent application referenced above.

Respectfully submitted,


Yingsheng Tung
Attorney for Applicants
Reg. No. 52,305

Texas Instruments Incorporated
P. O. Box 655474, M/S 3999
Dallas, Texas 75265
(972) 917-5355